# BCD-to-Seven-Segment Decoders/Drivers

The SN74LS247 is a BCD-to-Seven-Segment Decoder/Drivers.

The LS247 composes the  $\Box$  and  $\Box$  with the tails. The LS247 has active-low outputs for direct drive of indicators.

The LS247 features a lamp test input and have full ripple-blanking input/output controls. An automatic leading and/or trailing-edge zero-blanking control (RBI and RBO) is incorporated and an overriding blanking input (BI) is contained which may be used to control the lamp intensity by pulsing or to inhibit the output's lamp test may be performed at any time when the BI/RBO node is at high level. Segment identification and resultant displays are shown below. Display pattern for BCD input counts above 9 are unique symbols to authenticate input conditions.

- Open-Collector Outputs Drive Indicators Directly
- Lamp-Test Provision
- Leading/Trailing Zero Suppression

#### **GUARANTEED OPERATING RANGES**

Symbol	Parameter	Min	Тур	Мах	Unit
V <sub>CC</sub>	Supply Voltage	4.75	5.0	5.25	V
T <sub>A</sub>	Operating Ambient Temperature Range	0	25	70	°C
I <sub>ОН</sub>	Output Current – High BI/RBO			-50	μΑ
I <sub>OL</sub>	Output Current – Low BI/RBO			3.2	mA
V <sub>O(off)</sub>	Off–State Output Voltage a – g			15	V
I <sub>O(on)</sub>	On–State Output Current a – g			24	mA



#### ON Semiconductor Formerly a Division of Motorola

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LOW POWER SCHOTTKY



N SUFFIX CASE 648



#### **ORDERING INFORMATION**

Device	Package	Shipping
SN74LS247N	16 Pin DIP	2000 Units/Box
SN74LS247D	16 Pin	2500/Tape & Reel



CIRCUIT FEATURES LAMP INTENSITY MODULATION CAPABILITY

		TYPICAL			
TYPE	ACTIVE LEVEL	OUTPUT CONFIGURATION	SINK CURRENT	MAX VOLTAGE	POWER DISSIPATION
SN74LS247	low	open-collector	24 mA	15 V	35 mW

### LOGIC DIAGRAM





LS247						
FUNCTION TABLE						

DECIMAL OR			INP	UTS			BI/RBO <sup>†</sup>			C	UTPUT	S			NOTE
FUNCTION	LT	RBI	D	С	в	Α	Binbo	а	b	С	d	е	f	g	NOTE
0	Н	Н	L	L	L	L	Н	ON	ON	ON	ON	ON	ON	OFF	
1	Н	Х	L	L	L	Н	н	OFF	ON	ON	OFF	OFF	OFF	OFF	
2	Н	Х	L	L	Н	L	н	ON	ON	OFF	ON	ON	OFF	ON	
3	Н	Х	L	L	Н	Н	Н	ON	ON	ON	ON	OFF	OFF	ON	
4	Н	Х	L	Н	L	L	н	OFF	ON	ON	OFF	OFF	ON	ON	
5	Н	Х	L	Н	L	Н	н	ON	OFF	ON	ON	OFF	ON	ON	
6	Н	Х	L	Н	Н	L	н	ON	OFF	ON	ON	ON	ON	ON	
7	Н	Х	L	Н	Н	Н	н	ON	ON	ON	OFF	OFF	OFF	OFF	1
8	Н	Х	Н	L	L	L	н	ON	ON	ON	ON	ON	ON	ON	
9	Н	Х	н	L	L	Н	н	ON	ON	ON	ON	OFF	ON	ON	
10	Н	Х	н	L	Н	L	н	OFF	OFF	OFF	ON	ON	OFF	ON	
11	Н	Х	Н	L	Н	Н	Н	OFF	OFF	ON	ON	OFF	OFF	ON	
12	Н	Х	Н	Н	L	L	н	OFF	ON	OFF	OFF	OFF	ON	ON	
13	Н	Х	Н	Н	L	Н	н	ON	OFF	OFF	ON	OFF	ON	ON	
14	Н	Х	Н	Н	Н	L	н	OFF	OFF	OFF	ON	ON	ON	ON	
15	Н	Х	Н	Н	Н	Н	н	OFF	OFF	OFF	OFF	OFF	OFF	OFF	
BI	Х	Х	Х	Х	Х	Х	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	2
RBI	Н	L	L	L	L	L	L	OFF	OFF	OFF	OFF	OFF	OFF	OFF	3
LT	L	Х	Х	Х	Х	Х	Н	ON	ON	ON	ON	ON	ON	ON	4

H = HIGH Level, L = LOW Level, X = Irrelevant

NOTES: 1. The blanking input (BI) must be open or held at a high logic level when output functions 0 through 15 are desired. The ripple-blanking input (RBI) must be open or high if blanking of a decimal zero is not desired.

When a low logic level is applied directly to the blanking input (BI), all segment outputs are off regardless of the level of any other input.
When ripple-blanking input (RBI) and inputs A, B, C, and D are at a low level with the lamp test input high, all segment outputs go off and the ripple-blanking output (RBO) goes to a low level (response condition).
When the blanking input/ripple blanking output (BI/RBO) is open or held high and a low is applied to the lamp-test input, all segment outputs are on.
BI/RBO is wire-AND logic serving as blanking input (BI) and/or ripple-blanking output (RBO).

			Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions		
V <sub>IH</sub>	Input HIGH Voltage	2.0			V	Guaranteed Input HIGH Voltage for All Inputs		
V <sub>IL</sub>	Input LOW Voltage			0.8	V	Guaranteed Input LOW Voltage for All Inputs		
V <sub>IK</sub>	Input Clamp Diode Voltage		-0.65	-1.5	V	$V_{CC} = MIN, I_{IN} =$	–18 mA	
V <sub>OH</sub>	Output HIGH Voltage BI/RBO	2.4	4.2		V	$V_{CC}$ = MIN, $I_{OH}$ = MAX, $V_{IN}$ = $V_{IH}$ or $V_{IL}$ per Truth Table		
	Output LOW Voltage		0.25	0.4	V	l <sub>OL</sub> = 1.6 mA	$V_{CC} = V_{CC} MIN,$	
V <sub>OL</sub>	BI/RBO		0.35	0.5	V	I <sub>OL</sub> = 3.2 mA	V <sub>IN</sub> = V <sub>IL</sub> or V <sub>IH</sub> per Truth Table	
I <sub>O(off)</sub>	Off-State Output Current a-g			250	μΑ	$V_{CC} = MAX, V_{IH} = 2.0 \text{ V},$ $V_{O(off)} = 15 \text{ V}, V_{IL} = MAX$		
M	On-State Output Voltage		0.25	0.4	V	$I_{O(on)} = 12 \text{ mA}$ $V_{CC} = \text{MIN}, V_{IH} = 2$		
V <sub>O(on)</sub>	a-g		0.35	0.5	V	I <sub>O(on)</sub> = 24 mA	V <sub>IL</sub> per Truth Table	
				20	μΑ	$V_{CC} = MAX, V_{IN}$	= 2.7 V	
IIH	Input HIGH Current			0.1	mA	$V_{CC} = MAX, V_{IN}$	= 7.0 V	
IIL	Input LOW Current Any Input, except BI/RBO			-0.4	mA	V <sub>CC</sub> = MAX, V <sub>IN</sub> = 0.4 V		
	BI/RBO			-1.2	]			
I <sub>OS</sub>	Short Circuit Current BI/RBO (Note 1)	-0.3		-2.0	mA	V <sub>CC</sub> = MAX		
I <sub>CC</sub>	Power Supply Current		7.0	13	mA	V <sub>CC</sub> = MAX		

#### DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

# AC CHARACTERISTICS (V<sub>CC</sub> = 5.0 V, T<sub>A</sub> = 25°C)

		Limits					
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions	
t <sub>PLH</sub> t <sub>PHL</sub>	Turn-Off Time from A Input Turn-On Time from A Input			100 100	ns	C <sub>L</sub> = 15 pF, R <sub>L</sub> = 665 Ω	
t <sub>PHL</sub> t <sub>PLH</sub>	Turn-Off Time from RBI Input Turn-On Time from RBI Input			100 100	ns		

## PACKAGE DIMENSIONS



NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL. 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH. 5. ROUNDED CORNERS OPTIONAL.

	INC	HES	MILLIMETERS			
DIM	MIN	MAX	MIN	MAX		
Α	0.740	0.770	18.80	19.55		
В	0.250	0.270	6.35	6.85		
С	0.145	0.175	3.69	4.44		
D	0.015	0.021	0.39	0.53		
F	0.040	0.70	1.02	1.77		
G	0.100	BSC	2.54 BSC			
Н	0.050	BSC	1.27 BSC			
J	0.008	0.015	0.21	0.38		
К	0.110	0.130	2.80	3.30		
L	0.295	0.305	7.50	7.74		
М	0°	10 °	0 °	10 °		
S	0.020	0.040	0.51	1.01		

**D SUFFIX** PLASTIC SOIC PACKAGE CASE 751B-05 ISSUE J



NOTES:
DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
CONTROLLING DIMENSION: MILLIMETER.
DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION. SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIN	IETERS	INCHES			
DIM	MIN	MAX	MIN	MAX		
Α	9.80	10.00	0.386	0.393		
В	3.80	4.00	0.150	0.157		
С	1.35	1.75	0.054	0.068		
D	0.35	0.49	0.014	0.019		
F	0.40	1.25	0.016	0.049		
G	1.27	BSC	0.050 BSC			
J	0.19	0.25	0.008	0.009		
К	0.10	0.25	0.004	0.009		
М	0 °	7°	0 °	7°		
Р	5.80	6.20	0.229	0.244		
R	0.25	0.50	0.010	0.019		

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